

Title: METHOD FOR FORMING THIN FILM PATTERN, THIN FILM MANUFACTURING DEVICE, CONDUCTIVE THIN FILM WIRING, ELECTRO-OPTIC DEVICE, ELECTRONIC APPARATUS, AND NON-CONTACT CARD MEDIUM

Inventor(s): Hironori HASEI et al  
Atty. Ref.: 9319G-000567

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FIG. 1

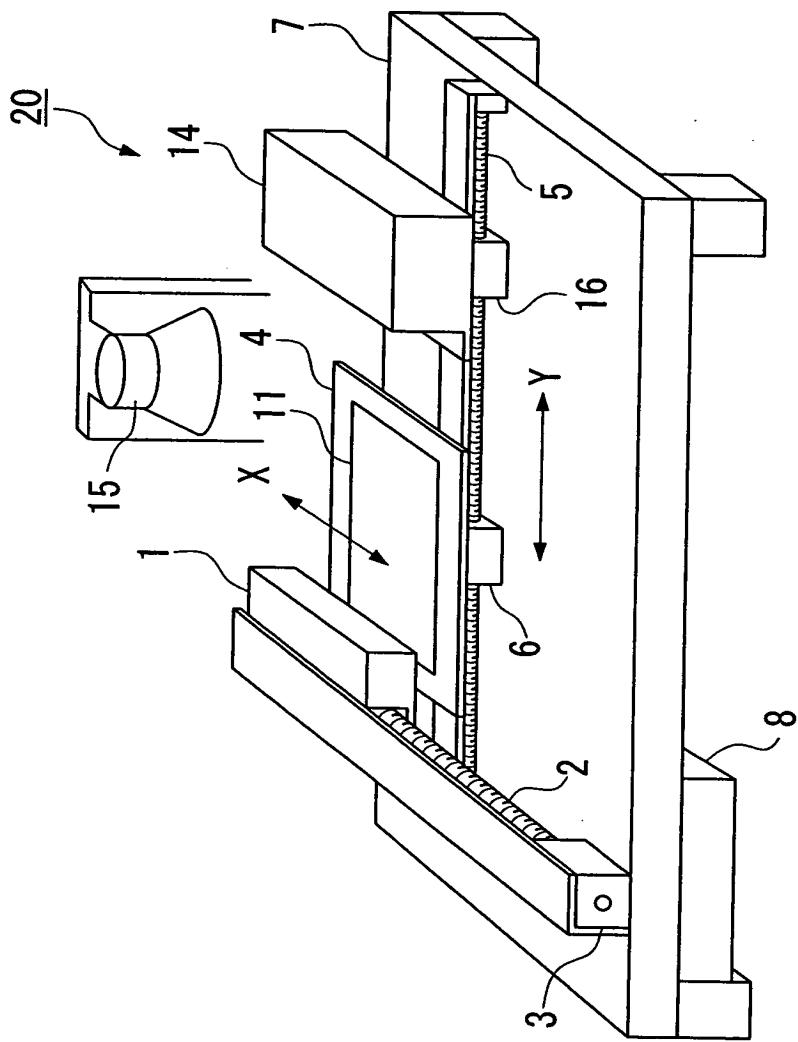


FIG. 2A

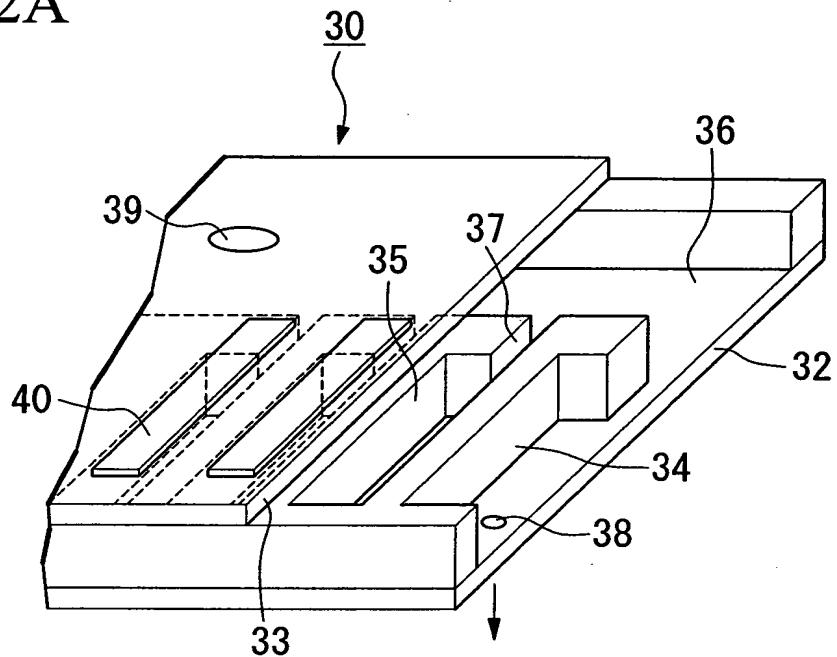
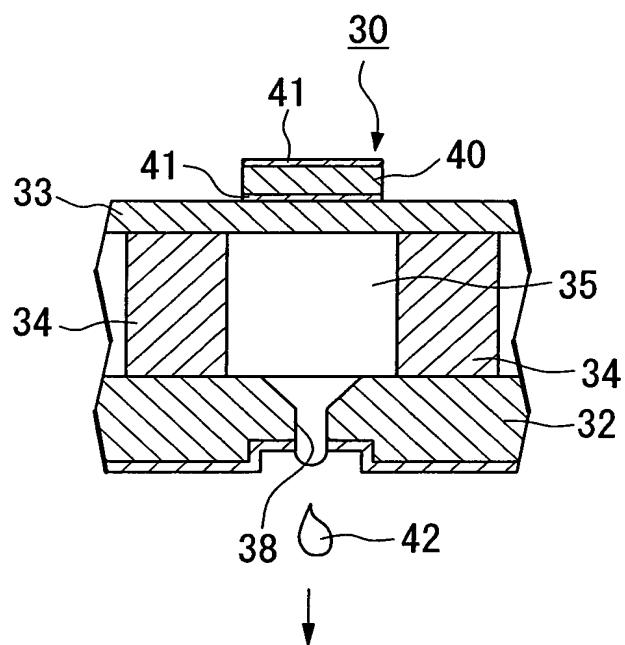


FIG. 2B



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FIG. 3

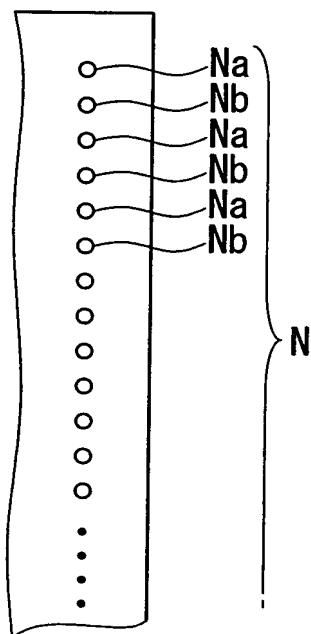


FIG. 4A

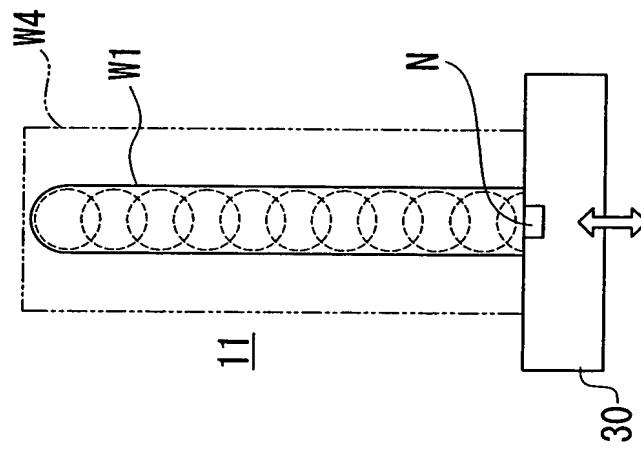


FIG. 4B

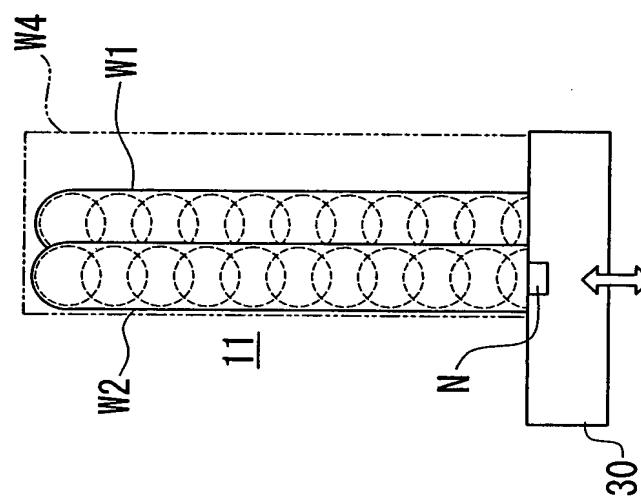


FIG. 4C

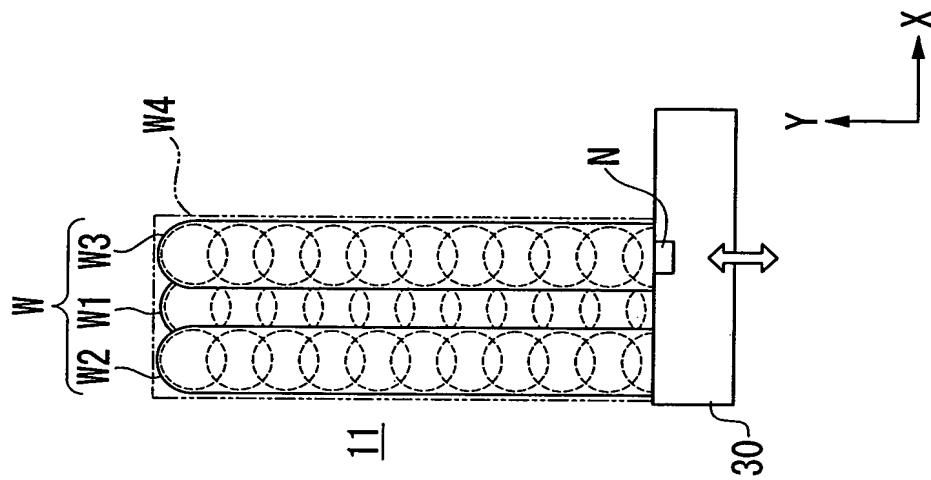


FIG. 5A

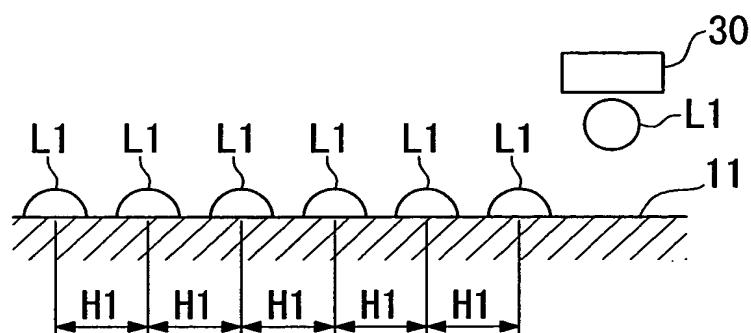


FIG. 5B

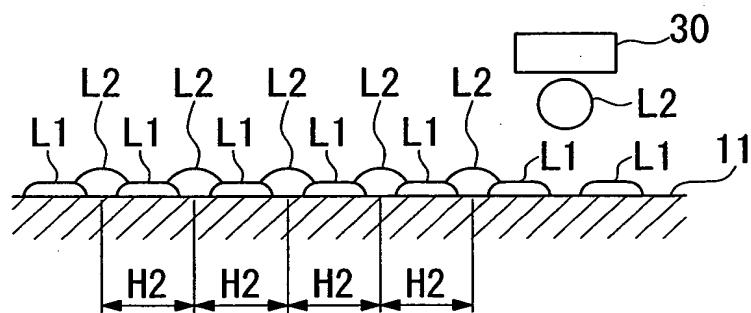


FIG. 5C

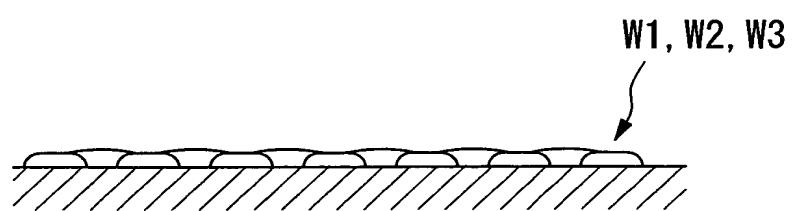


FIG. 6A

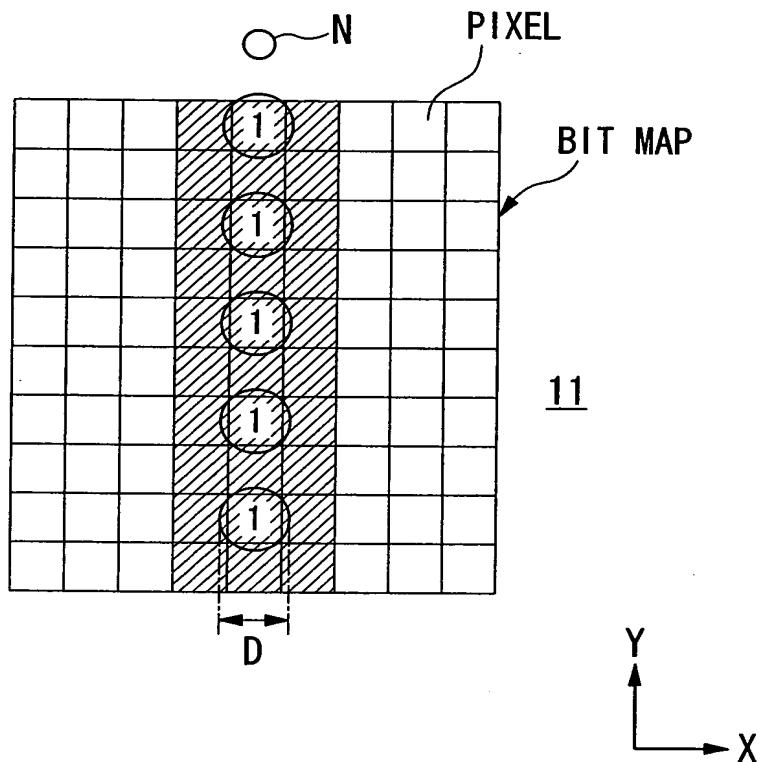


FIG. 6B

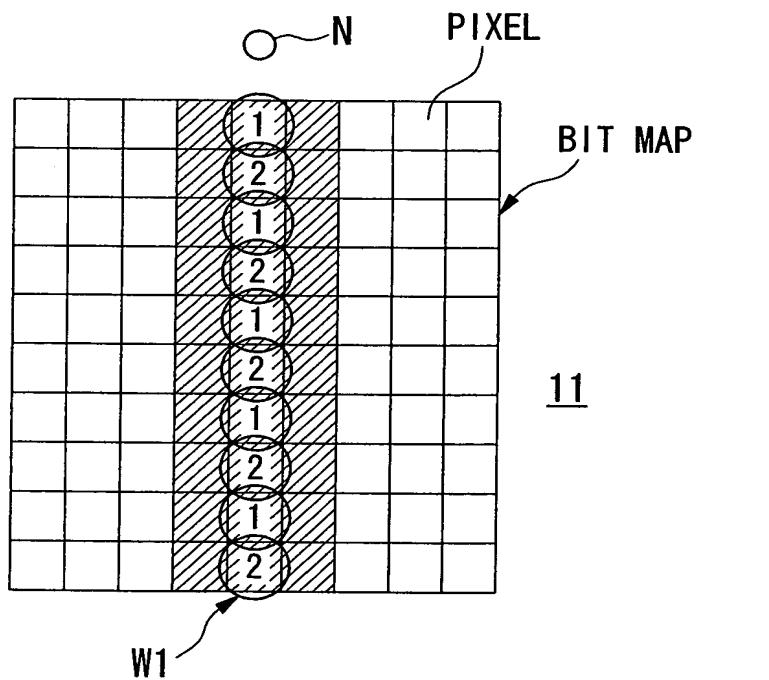


FIG. 7A

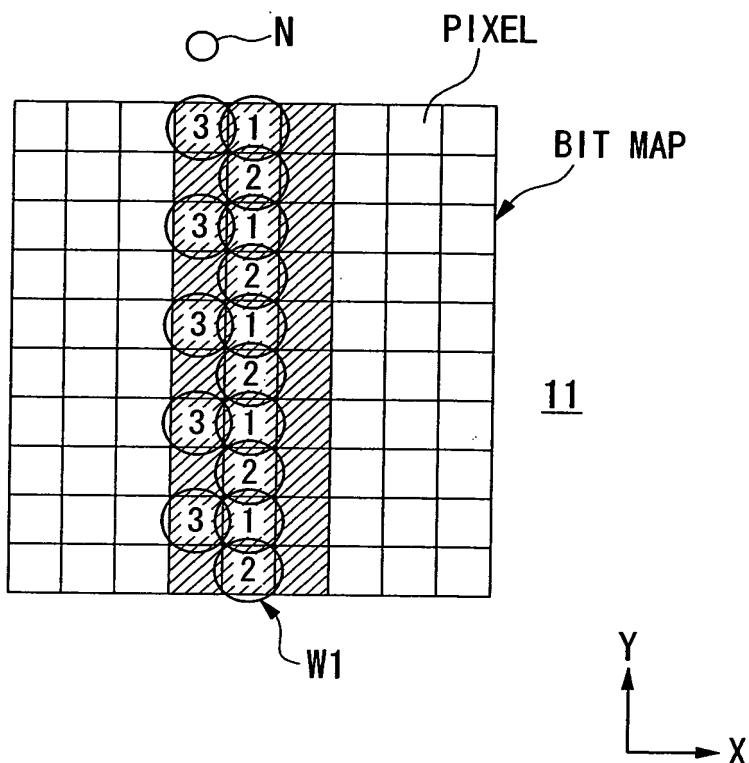
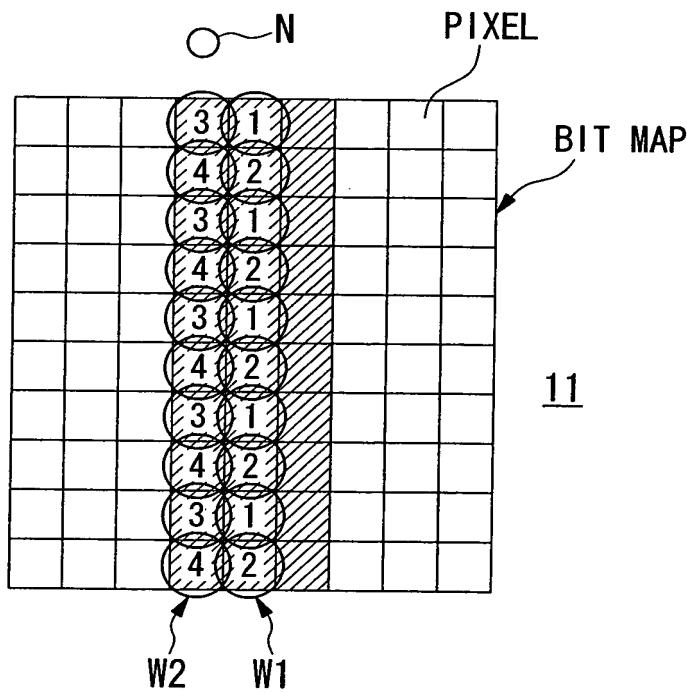


FIG. 7B



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FIG. 8A

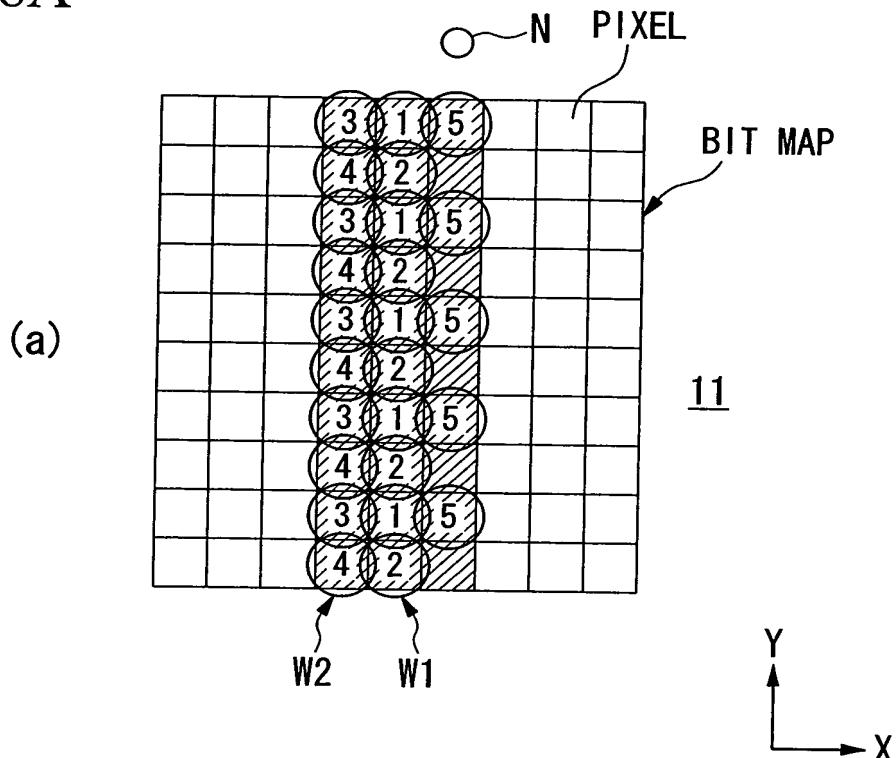
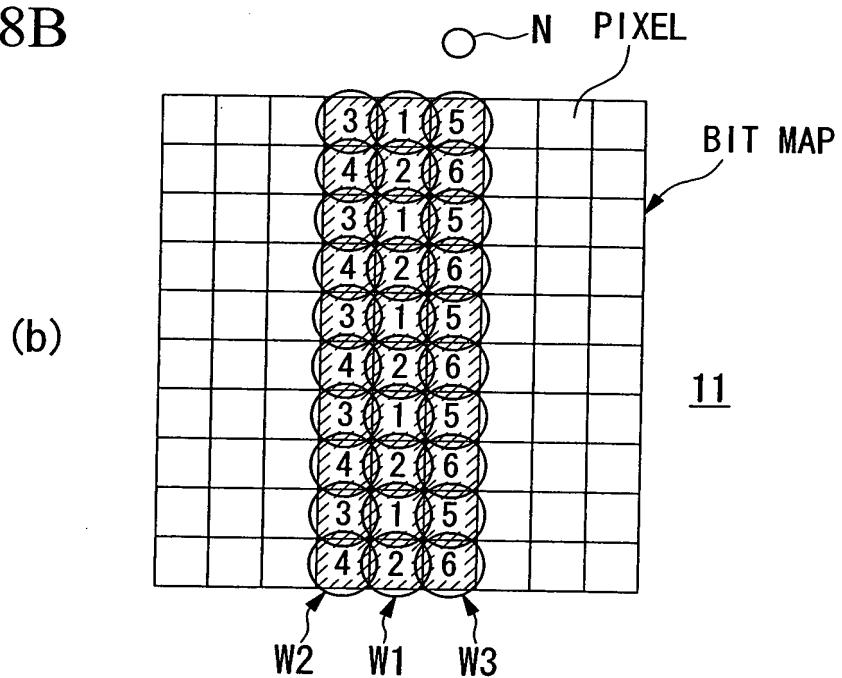


FIG. 8B



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FIG. 9

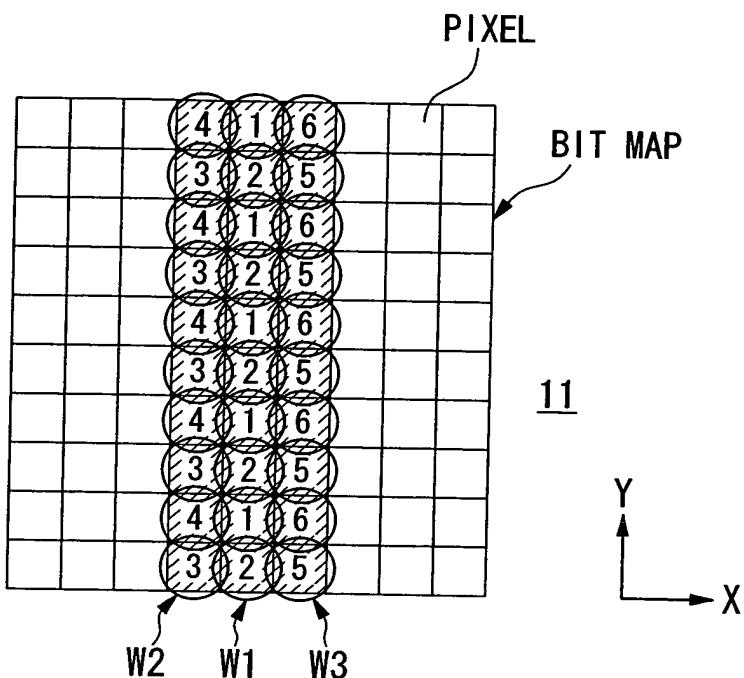
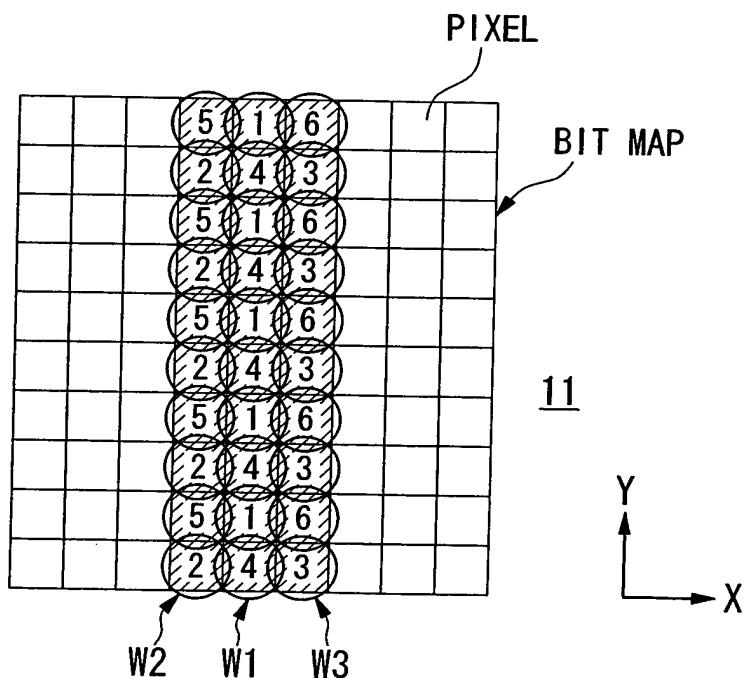


FIG. 10



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FIG. 11A

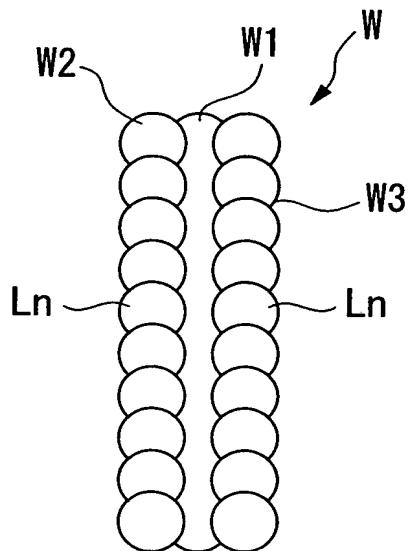
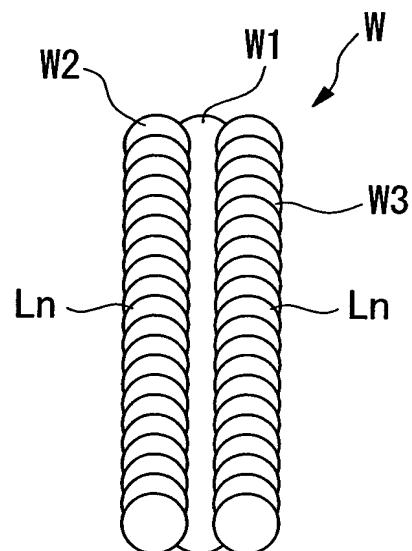


FIG. 11B



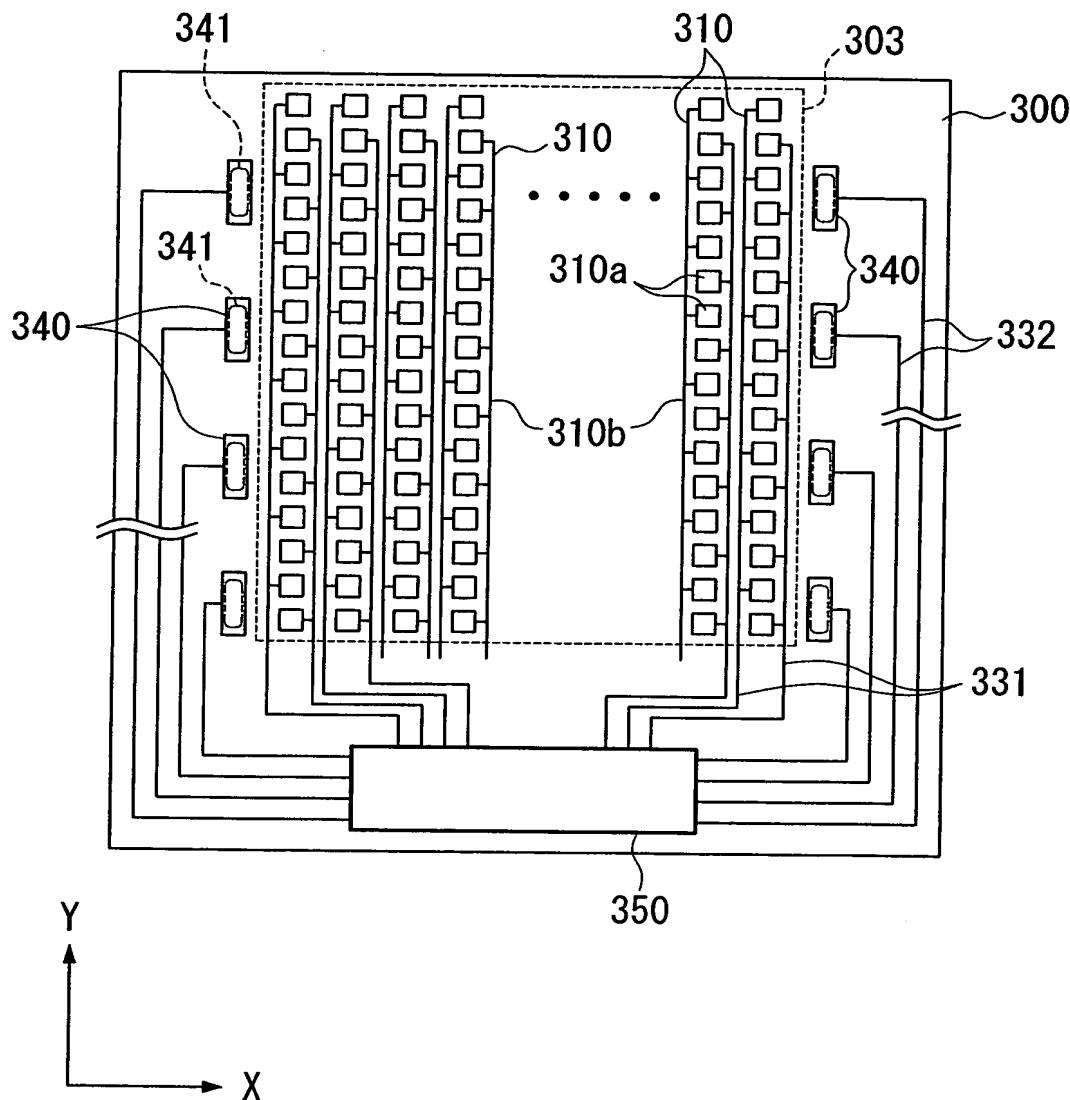
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FIG. 12



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FIG. 13A

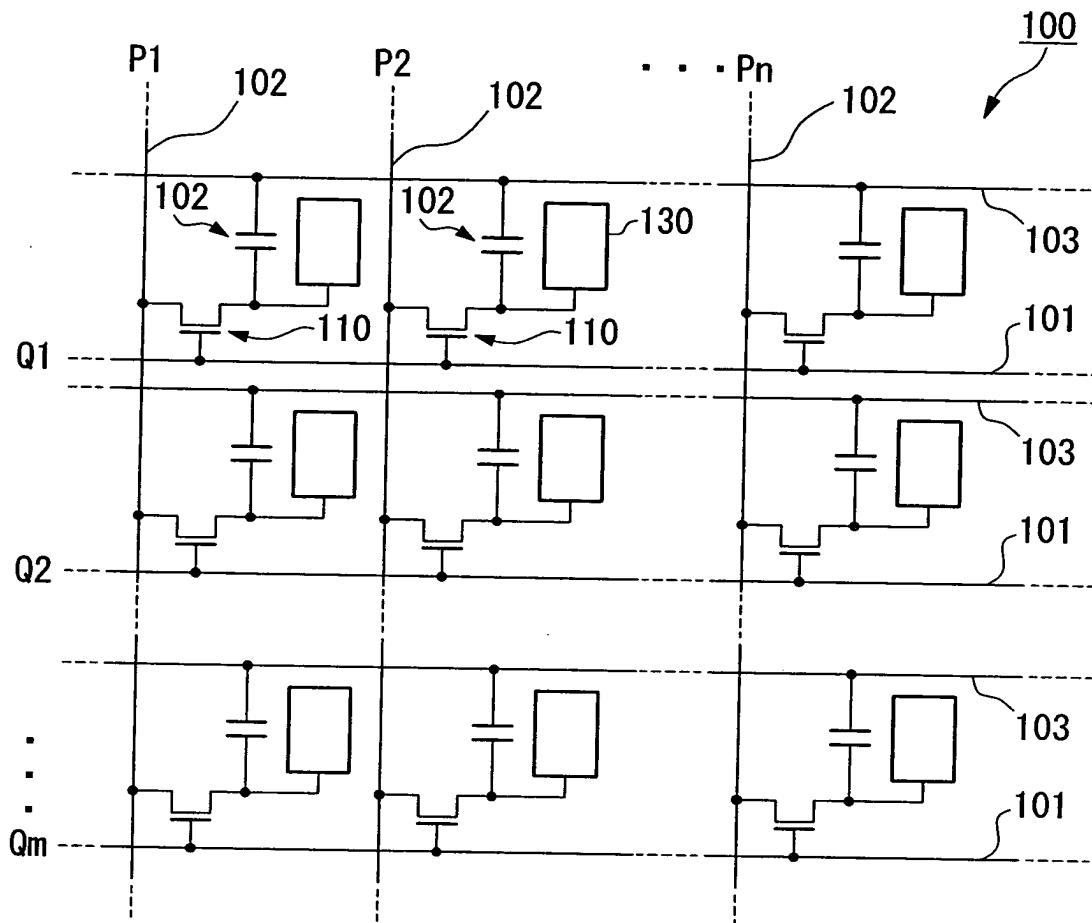


FIG. 13B

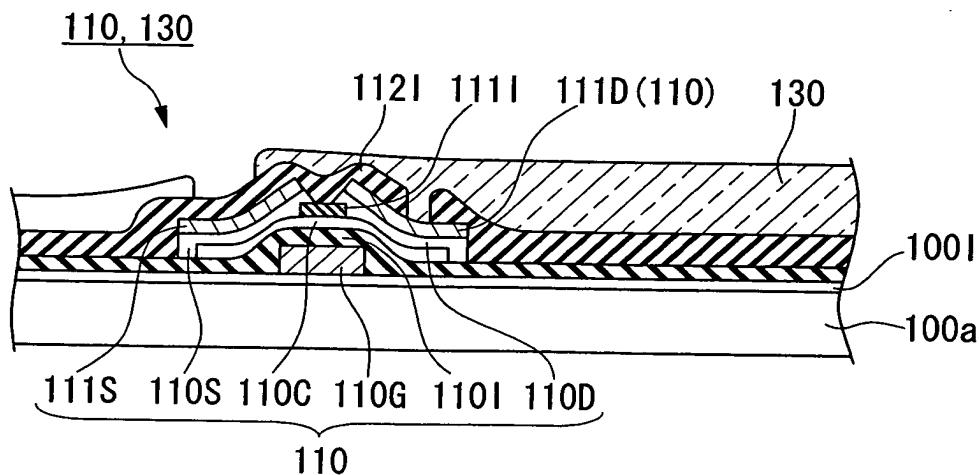


FIG. 14B

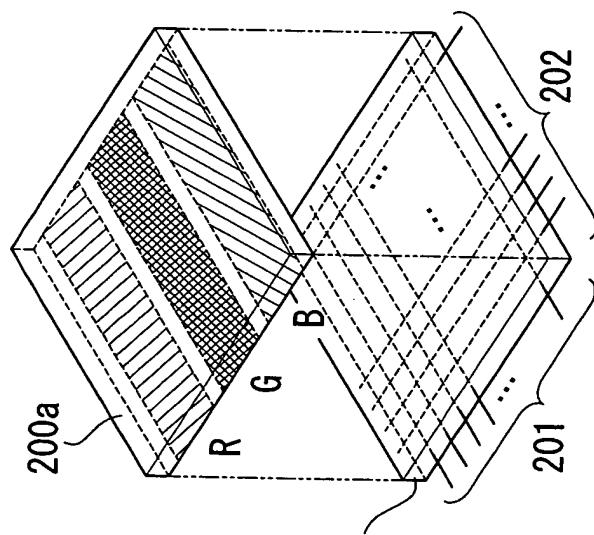
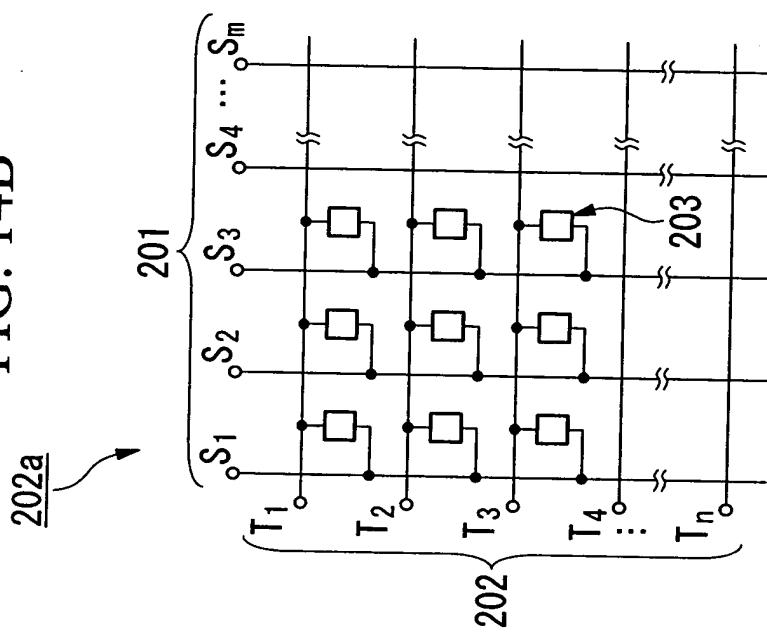


FIG. 14A

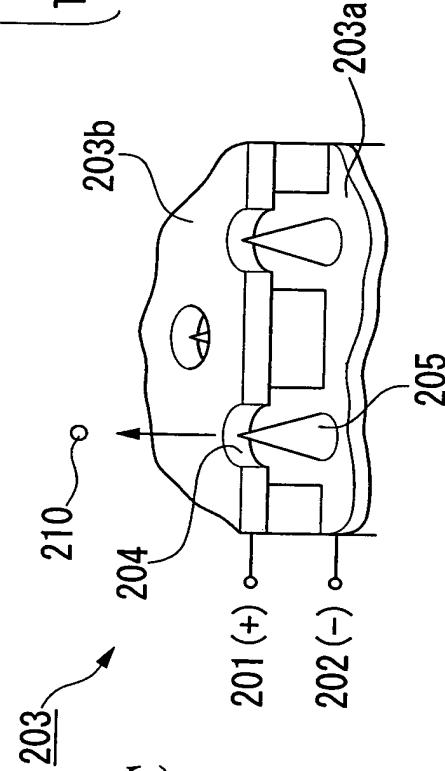


FIG. 14C

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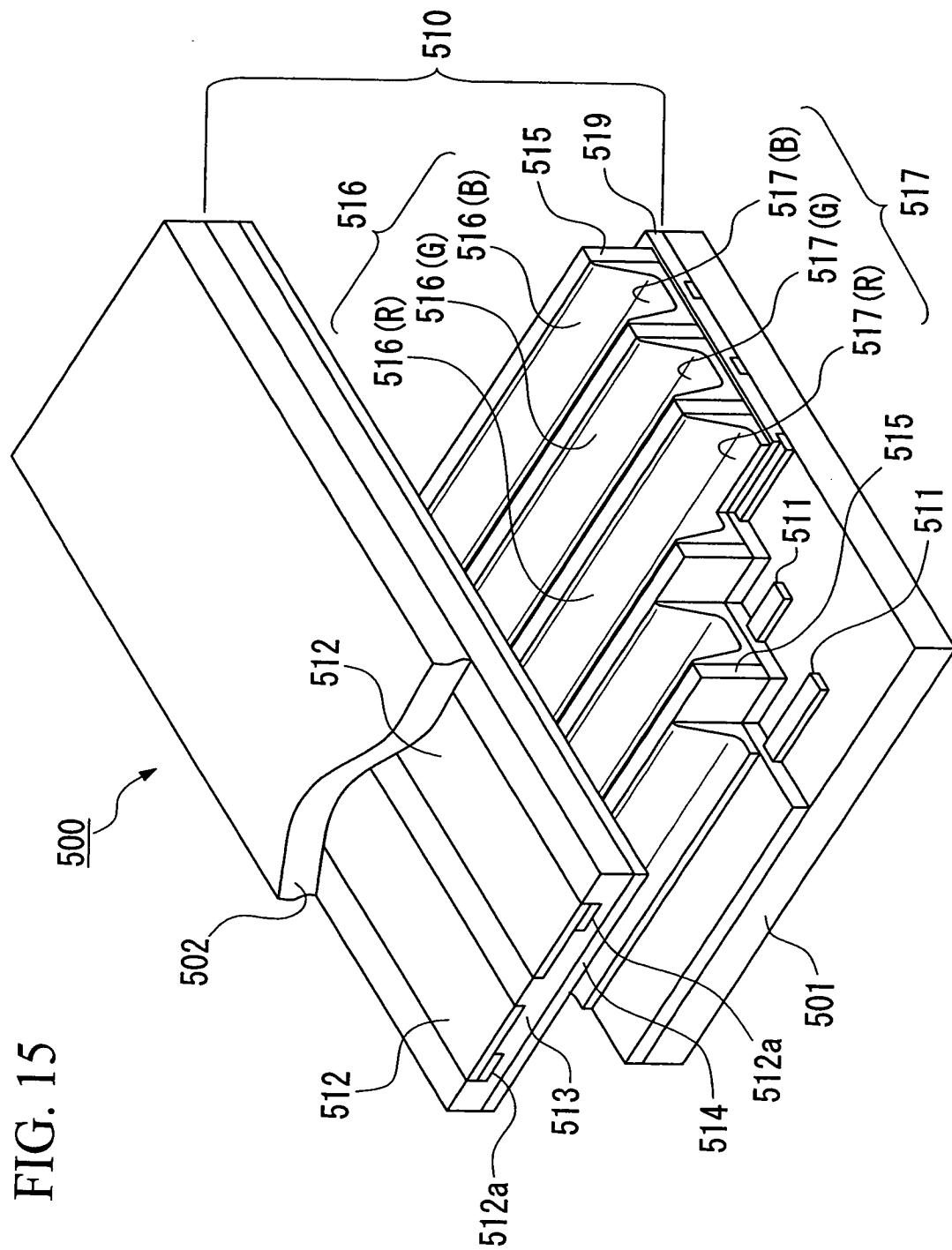


FIG. 16A

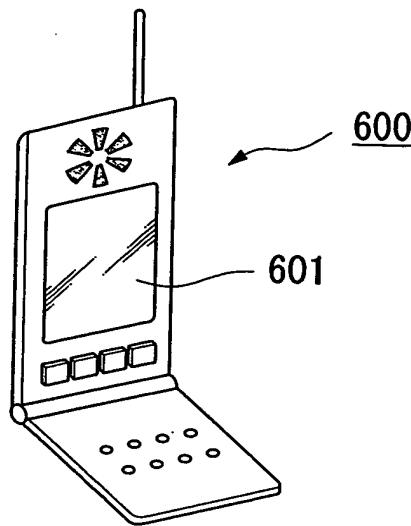


FIG. 16B

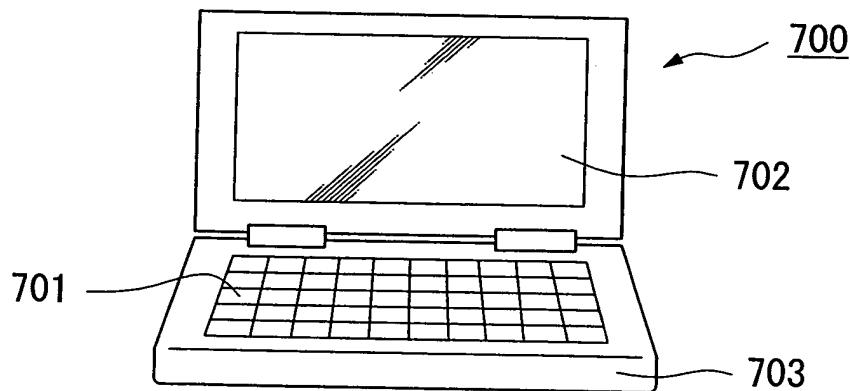


FIG. 16C

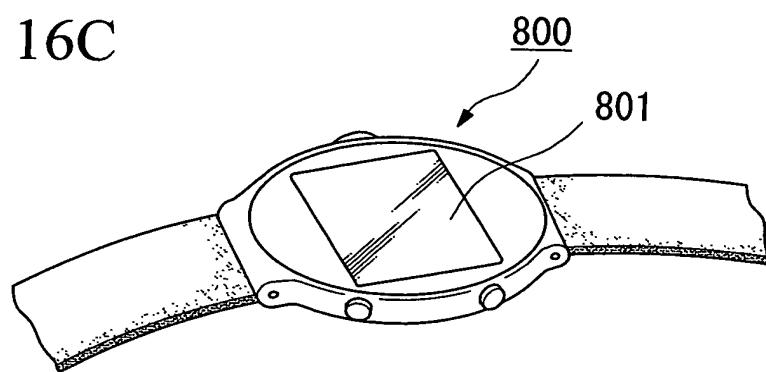
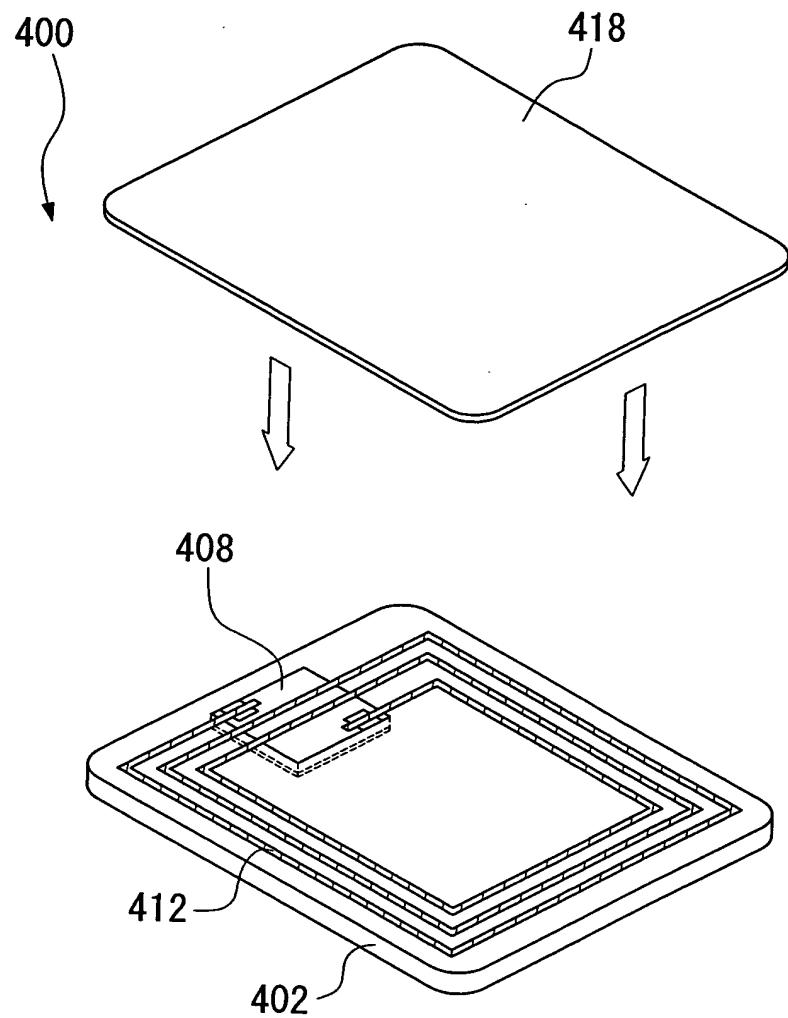


FIG. 17



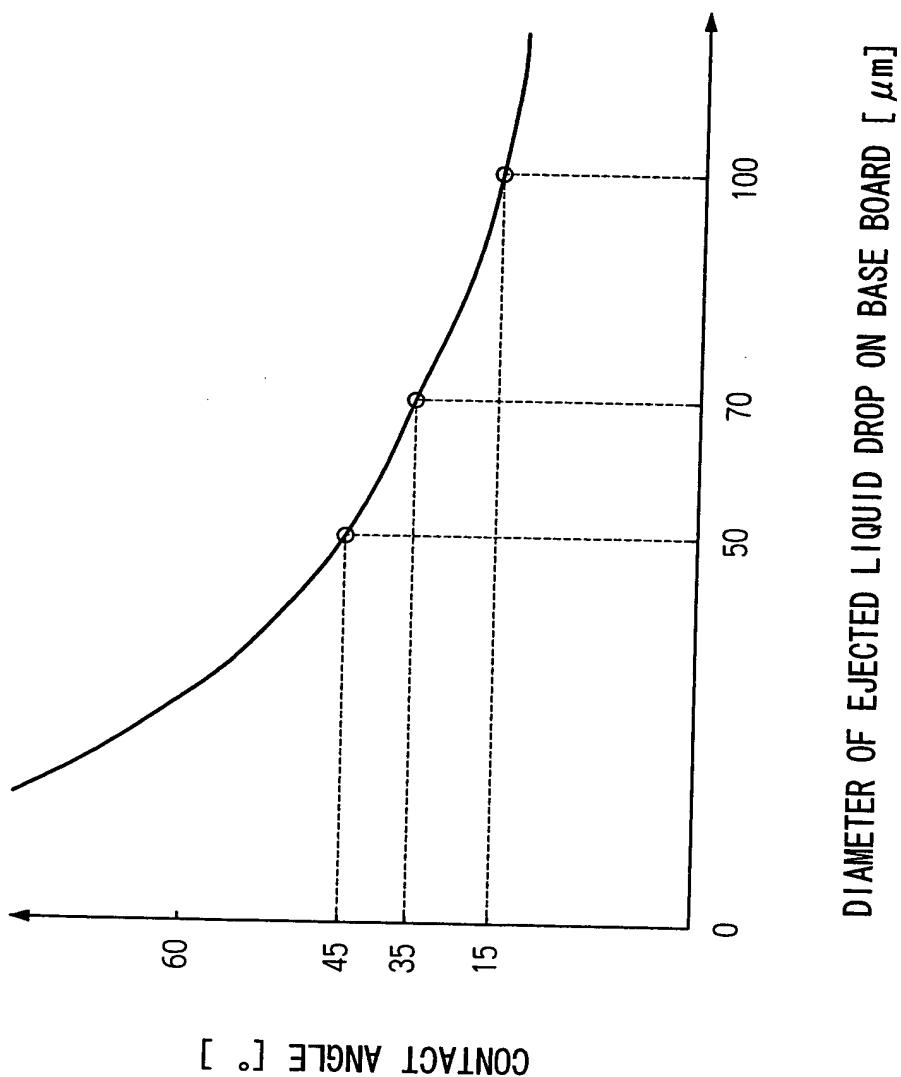
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FIG. 18



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FIG. 19A

FIG. 19B

